TRADEMARK ASSIGNMENT

Electronic Version v1.1
Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNS THE ENTIRE INTEREST AND THE GOODWILL

CONVEYING PARTY DATA

Name	Formerly	Execution Date	Entity Type
Deutsche Bank Trust AG New York Branch, as resigning administrative agent and collateral agent		02/23/2011	Bank: GERMANY

RECEIVING PARTY DATA

Name:	JPMorgan Chase Bank, N.A., as Collateral Agent
Street Address:	1111 Fannin Street, 10th Floor
City:	Houston
State/Country:	TEXAS
Postal Code:	77002
Entity Type:	National Association: UNITED STATES

PROPERTY NUMBERS Total: 39

Property Type	Number	Word Mark
Registration Number:	1021345	ARACAST
Registration Number:	2713897	ARADUR
Registration Number:	437125	ARALDITE
Registration Number:	442493	ARALDITE
Registration Number:	2187502	ARALDITE
Registration Number:	1580878	ARATHANE
Registration Number:	1539906	AROCY
Registration Number:	612844	EPOCAST
Registration Number:	2886879	EPOSERT
Registration Number:	2286963	KERIMID
Registration Number:	1437618	MATRIMID
Registration Number:	2773878	OPALVA
Registration Number:	2384635	PROBELEC

OP $990.00 1021345

Registration Number:	1773326	PROBIMAGE
Registration Number:	1025999	PROBIMER
Registration Number:	1783753	PROBIMER
Registration Number:	678703	REN
Registration Number:	710081	REN
Registration Number:	2200608	REN PATCH
Registration Number:	2208182	REN SHAPE
Registration Number:	707695	REN SHAPE
Registration Number:	2433986	REN SHAPE-EXPRESS
Registration Number:	2938093	RENCAST
Registration Number:	2930911	RENGEL
Registration Number:	2938092	RENINFUSION
Registration Number:	2954970	RENLAM
Registration Number:	2938091	RENLEASE
Registration Number:	2938090	RENPASTE
Registration Number:	2928026	RENPIM
Registration Number:	2929010	RENSHAPE
Registration Number:	2936305	RENSHAPE
Registration Number:	1555383	SILFLEX
Registration Number:	1373234	TACTIX
Registration Number:	1967928	URALANE
Registration Number:	1463200	WEARGUARD
Registration Number:	613707	EPIBOND
Registration Number:	1341836	QUATREX
Registration Number:	2077435	REN-WELD
Registration Number:	2481643	PUR-FECT TOOL

CORRESPONDENCE DATA

Fax Number: (800)516-6304

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 614-280-3566

Email: james.murray@wolterskluwer.com

Correspondent Name: Jim Murray

Address Line 1: 4400 Easton Commons Way, Suite 125

Address Line 2: CT Lien Solutions

Address Line 4: Columbus, OHIO 43219

NAME OF SUBMITTER:	James P. Murphy

Signature:	/James P. Murphy/
Date:	02/28/2011

Total Attachments: 10
source=Trademark Filing Huntsman Advanced Materials#page2.tif
source=Trademark Filing Huntsman Advanced Materials#page3.tif
source=Trademark Filing Huntsman Advanced Materials#page4.tif
source=Trademark Filing Huntsman Advanced Materials#page5.tif
source=Trademark Filing Huntsman Advanced Materials#page6.tif
source=Trademark Filing Huntsman Advanced Materials#page7.tif
source=Trademark Filing Huntsman Advanced Materials#page8.tif
source=Trademark Filing Huntsman Advanced Materials#page9.tif
source=Trademark Filing Huntsman Advanced Materials#page10.tif
source=Trademark Filing Huntsman Advanced Materials#page11.tif

PATENT AND TRADEMARK ASSIGNMENT AND ASSUMPTION

This PATENT AND TRADEMARK ASSIGNMENT AND ASSUMPTION dated as of February 23, 2011 (this "Assignment and Assumption") is made by Deutsche Bank AG New York Branch, as resigning administrative agent and collateral agent, as assignor ("Assignor") and JPMorgan Chase Bank, N.A., as successor administrative agent and collateral agent, as assignee ("Assignee").

WHEREAS, reference is made to (i) that certain Credit Agreement dated as of August 16, 2005 (as amended, supplemented or otherwise modified, the "Credit Agreement"), by and among Huntsman International LLC, as borrower (the "Borrower"), Deutsche Bank AG New York Branch, as administrative agent (in such capacity, the "Administrative Agent") and certain parties party thereto, (ii) that certain Collateral Security Agreement dated as of August 16, 2005 by and among each of the Borrower, the Administrative Agent and other parties party thereto (as amended, supplemented or otherwise modified, the "Collateral Agreement"), and (iii) that certain Pledge Agreement dated as of August 16, 2005 by and among each of the Borrower, the Administrative Agent and other parties party thereto (as amended, supplemented or otherwise modified, the "Pledge Agreement" and together with the Collateral Agreement, the "Security Agreements"); capitalized terms not defined herein shall have the meanings assigned to them in the Collateral Agreement;

WHEREAS, reference is also made to the Grant of Security Interest in United States Trademarks and Patents dated December 20, 2005, by and between Huntsman Advanced Materials Americas Inc., a Delaware corporation (n/k/a Huntsman Advanced Materials Americas LLC) (the "Grantor"), and the Administrative Agent (the "Intellectual Property Security Agreement"); and

WHEREAS, pursuant to the Intellectual Property Security Agreement recorded with the U.S. Patent and Trademark Office at Reel 017045, Frame 0309 on November 21, 2005, Reel 017164, Frame 0639 on January 20, 2006, and Reel 3252, Frame 0432 on January 20, 2006, the Grantor granted the Administrative Agent a lien on and security interest in and to all of its right, title and interest in, to and under certain of its intellectual property Collateral, including the Patents and Marks listed on Schedule I hereto and proceeds of any and all of the foregoing;

WHEREAS, pursuant to (i) the Fifth Amendment to Credit Agreement, dated as of March 9, 2010 (the "Fifth Amendment"), among the Borrower and the Required Lenders (as defined in the Credit Agreement) and (ii) the Successor Agency Agreement, dated as of March 9, 2010 (the "Successor Agency Agreement"), between Assignor and Assignee, the Credit Agreement has been amended to reflect, among other things, the appointment of Assignee as successor administrative agent and collateral agent; and

WHEREAS, in furtherance of Assignee's replacement of Assignor as the Administrative Agent under the Credit Agreement, Assignee is desirous of acquiring and Assignor is desirous of assigning all of its right, title and interest in, to and under the Intellectual Property Security Agreement, including without limitation the Assigned Interest (as defined below), and all documents relating thereto.

NOW THEREFORE, in consideration of the foregoing premises and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each of the parties hereto agree as follows:

Assignor hereby irrevocably, absolutely and unconditionally assigns to Assignee without recourse and without any representation or warranty of any kind, nature or description, except as expressly set forth in the Successor Agency Agreement, and Assignee hereby assumes from Assignor, the interest in and to Assignor's rights and obligations under the Intellectual Property Security Agreement (the "Assigned Interest") and all Patents and Marks listed on Schedule I hereto, as of the Effective Date (as defined below).

The effective date of this Assignment and Assumption shall be the date of execution by all parties (the "Effective Date"). Following the execution of this Assignment and Assumption, it will be delivered to Cahill Gordon & Reindel LLP for recording on behalf of the parties hereto pursuant to the Security Agreements and the Intellectual Property Security Agreement with the United States Patent and Trademark Office.

From and after the Effective Date and as further set forth in the Successor Agency Agreement, (a) Assignee shall be a party to the Credit Agreement, the Security Agreements, and the Intellectual Property Security Agreement and, to the extent provided in this Assignment and Assumption, have the rights and obligations of the Administrative Agent thereunder and shall be bound by the provisions thereof and (b) Assignor shall and does hereby, to the extent provided in this Assignment and Assumption and the Successor Agency Agreement, relinquish its rights and shall be and is hereby released from its obligations under the Credit Agreement, the Security Agreements and the Intellectual Property Security Agreement. Assignor hereby fully terminates, releases and discharges the security interest granted to Assignor by Borrower in the Patents and Marks listed on Schedule 1 hereto, including, without limitation, the proceeds of such Patents and Marks. Nothing set forth herein shall modify or limit in any respect the provisions of the Successor Agency Agreement.

This Assignment and Assumption shall be governed by and construed in accordance with the laws of the State of New York.

This Assignment and Assumption may be executed by one or more of the parties to this Assignment and Assumption in any number of separate counterparts (including by telecopy or Adobe PDF), and all of said counterparts taken together shall be deemed to constitute one and the same instrument.

[*Remainder of Page Intentionally Left Blank*]

IN WITNESS WHEREOF, the parties hereto have caused this Assignment and Assumption to be executed by their respective duly authorized officers.

DEUTSCHE BANK AG NEW YORK BRANCH,
as Assignor

By: _____
Name: Omayra Laucella
Title: Vice President

By: _____
Name: Evelyn Thierry
Title: Director

Accepted:

JPMORGAN CHASE BANK, N.A.,
as Assignee

By: _____
Name: Gitanjali Pundir
Title: Vice President

SCHEDULE I
to
PATENT AND TRADEMARK ASSIGNMENT AND ASSUMPTION

PATENTS

Application Number	Application Date	Patent Number	Grant Date	Patent
918064	8/25/1997	6017615	1/25/2000	FILM PRODUCT COMPRISING NOVEL POLYOLEFINS
07/823513	8/17/1988	5278257	1/11/1994	Phenol-terminated polyurethane or polyurea(urethane) with epoxy resin
08/437737	10/24/1990	5573889	11/12/1996	Process for adjusting the sensitivity of Photopo.
07/856240	3/25/1992	5322907	6/21/1994	VERWENDUNG BESTIMMTER POLYGLYCIDYLESTER ZUR HERSTELLUNG WITTE
08/303563	3/25/1992	5476749	12/19/1995	PHOTOSENSITIVE COMPOSITIONS BASED ON ACRYLATES
07/861705	4/1/1992	5274054	12/27/1993	Adducts from epoxy resins and amines
07/875880	4/29/1992	5237036	8/17/1993	Polyol components for the preparation of molded articles of polyurethanes
08/231953	6/1/1992	5487966	1/30/1996	PHOTOSENSITIVE COMPOSITIONS
08/284729	6/24/1992	5451616	9/19/1995	Photopolymerisable liquid compositions
08/443949	6/24/1992	5620553	4/15/1997	Photopolymerisable liquid compositions .
07/952123	9/28/1992	5294683	3/15/1994	FESTE LÖSUNGEN AUS FESTEN UND FLÜSSIGEN POLYGYCIDYLVERBINDUNG 5
08/384793	9/28/1992	5457168	10/10/1995	FESTE LÖSUNGEN AUS FESTEN UND FLÜSSIGEN POLYGYCIDYLVERBINDUNG
08/096136	7/22/1993	5340900	8/23/1994	Hardener composition for the production of polyurethane shaped articles
08/129703	9/30/1993	5342867	8/30/1994	Adhesion promoters
08/166767	12/14/1993	5476748	12/19/1995	Photosensitive compositions
08/166763	12/14/1993	5449704	9/12/1995	Photopolymerisable liquid compositions
08/376539	12/16/1993	5470896	11/28/1995	LAGERSTABILE LÖSUNGEN VON BESCHLEUNIGERSYSTEMEN
08/169938	12/20/1993	5468886	11/21/1995	New (cyclo)aliphatic epoxy compounds
08/200982	2/24/1994	5470689	11/28/1995	Tetra-acrylates containing polymerizable mixtures
08/286061	8/4/1994	5495029	2/27/1996	(Meth)acrylates containing urethanes

Application Number	Application Date	Patent Number	Grant Date	Patent
08/552643	8/4/1994	5658712	8/19/1997	(Meth)acrylates containing urethanes
08/292654	8/18/1994	5461088	10/24/1995	Radiation curable liquid composition, particularly for stereolithography
08/449172	8/18/1994	5629133	5/13/1997	Radiation curable liquid composition, particularly for stereolithography .
08/304464	9/12/1994	5605941	2/25/1997	Vinylether compounds with additional functional groups differing from vinylether and their use in the formulation of curable compositions
08/834404	9/12/1994	5783615	7/21/1998	Vinylether compounds with additional functional groups differing from vinylether and their use in the formulation of curable compositions.
08/689747	9/12/1994	5783712	7/21/1998	Vinylether compounds with additional functional groups differing from vinylether and their use in the formulation of curable compositions
08/586840	7/27/1994	5708120	1/13/1998	Gelled reactive resin compositions .
08/944672	7/27/1994	5908901	6/1/1999	Gelled reactive resin compositions .
08/779181	8/15/1995	5821318	10/13/1998	POLY(METHYLENCYCLOHEXANAMIN)-GEMISCHE MIT MONOPHENOLEN UND A
08/611914	3/6/1996	5783358	7/21/1998	Stabilization of liquid radiation-curable compositions against premature polymerization
09/298572	10/17/1996	6433084	8/13/2002	PULVERLACKE AUF BASIS VON FESTEN POLY(METH)ACRYLHARZEN MIT FR .
09/016619	10/17/1996	6265487	7/24/2001	PULVERLACKHÄRTER ENTHALTEND TRANS-1,4-CYCLOHEXANDICARBONSÄURE
09/091452	12/10/1996	5989475	11/23/1999	Process for the stereolithographic preparation of three-dimensional objects using a radiation-curable liquid formulation which contains fillers
09/142269	2/28/1997	6258919	7/10/2001	HÄRTBARE EPOXYDHARZZUSAMMENSETZUNGEN ENTHALTEND WASSERVERARBE
08/820822	3/19/1997	5859096	1/12/1999	One-component epoxy resin tooling material
08/901303	7/28/1997	5972563	10/26/1999	Liquid radiation-curable compositions, in particular for stereolithography
08/999527	7/17/1997	5942182	8/24/1999	Resin transfer molding process using stable epoxy resin compositions. ONE COMPONENT ROOM TEMPERATURE STABLE EPOXY RESIN COMPOSITIONS FOR VARTM/RTM SYSTEMS
08/947997	10/9/1997	6077886	6/20/2000	Curable resin compositions
09/986815	11/13/2001	6831113	12/14/2004	AMINE-MODIFIED EPOXY RESIN REACTED IN PRESENCE OF LATENT HARDENER .

Application Number	Application Date	Patent Number	Grant Date	Patent
09/077049	11/18/1996	6346573	2/12/2002	Reactive resin manufacture
09/115085	7/14/1998	6177232		Sedimentation Stabilized Radiation-curable filled compositions
09/584444	5/31/2000	6350403	2/26/2002	Photocurable Compositions with Alicyclic Epoxides of High Monomer Purity. Viscosity stabilization of radiation-curable filled compositions.
08/201146	5/1/1991	5437964	8/1/1995	Stereolithography using vinyl ether-epoxide polymers .
08/230444	5/1/1991	5510226	4/23/1996	Stereolithography using vinyl ether-epoxide polymers ..
08/231353	2/27/1991	5506087	4/9/1996	TEREOLITHOGRAPHY USING VINYL ETHER BASED POLYMERS
08/266829	6/27/1994	5494618	2/27/1996	Increasing the useful range of cationic photoinitiators in stereolithography
08/463086	6/27/1994	5705116	1/6/1998	Increasing the useful range of cationic photoinitiators in stereolithography
09/050279	3/30/1998	6136497	10/24/2000	Liquid, radiation-curable composition, especially for producing flexible cured articles by stereolithography
09/645944	3/30/1998	6413697	7/2/2002	Liquid, radiation-curable composition, especially for producing flexible cured articles by stereolithography
10/167436	6/13/2002			Liquid, radiation-curable composition, especially for producing flexible cured articles by stereolithography
09/055832	4/6/1998	6100007	8/8/2000	Liquid, radiation-curable composition, especially for producing cured articles by stereolithography having high heat deflection temperatures
09/787165	9/4/1999	6465601	10/15/2002	BESCHLEUNIGER FÜR HÄRTBARE SYSTEME
08/224503	10/2/1991	5514519	5/7/1996	Production of three-dimensional objects
08/643790	10/2/1991	5677107	10/14/1997	Production of three-dimensional objects
08/893835	10/2/1991	5942370	8/24/1999	Production of three-dimensional objects .
07/649100	2/1/1991	5230986	7/27/1993	PHOTOSENSITIVE COMPOSITIONS CONTAINING BENZOSPIROPYRANS AND USES THEREOF
09/937001	3/7/2000	6881769	4/19/2005	Matting Agents for Thermally Curable Systems
09/380449	3/7/1997	6277929	8/21/2001	Polymerizable unsaturated compounds curable resin compositions containing the same and cured molded articles thereof
10/018667	6/6/2000	6774250	8/10/2004	Process for the preparation of reaction products of cycloaliphatic epoxides with multifunctional hydroxy compounds
10/088564	7/1/2002	6855748	2/15/2005	UV-Curable Compositions

Application Number	Application Date	Patent Number	Grant Date	Patent
11/054208	2/8/2005	7202286	4/10/2007	UV-Curable Compositions
10/182412	1/23/2001	7141629	11/28/2006	Epoxy Resin Composition
10/380392	9/4/2001			Seamless Model and Method of Making a Seamless Model
10/416978	11/6/2001	7097958	8/29/2006	Positive Type Photosensitive Epoxy Resin Composition and Printed Circuit Board Using the Same
08/913466	3/6/1996	6025114	2/15/2000	Liquid Photocurable Compositions
08/705846	8/30/1996	6133336	10/17/2000	Process for producing polymeric layers having selectively coloured regions
09/071746	10/18/1996	6001298	12/14/1999	Processes for preparing and using moulds
10/466944	11/20/2001	7053138	5/30/2006	Flame Proofing Agents
10/472100	3/6/2002	7001977	2/21/2006	Adducts of Polyalkylene Glycol Monoglycidyl Ethers and Amine Compounds
10/399444	2/12/2002	7455804	11/25/2008	Three Dimensional Structured Printing
10/468329 [2]	2/12/2002			Three Dimensional Printing
10/479303	5/24/2002	7578958	8/25/2009	Three-Dimensional Structured Printing
10/485440	7/29/2002	7217771	5/15/2007	EPOXY RESIN
10/498692 [2]	12/13/2002			Method of Making Models
10/495028	11/11/2002	7416764	8/26/2008	Production of Composites Articles Composed of Thin Layers
10/515793	5/23/2003	7655174	2/2/2010	Jettable Compositions
10/516978	6/4/2003	7595351	9/29/2009	Actinic Radiation Curable Compositions and their Use
10/494916	11/6/2002			Tool Made from Plastic
10/520055	12/20/2002	7579399	8/25/2009	Tool Consisting of Plastic Material
10/539844	12/18/2003	7635728	12/22/2009	Flame retardant polymer compositions
10/678253	10/1/2003	7232850	6/19/2007	Photocurable Compositions for Articles having Stable Tensile Properties
10/498036	11/21/2002	7387812	6/17/2008	Heat Curable Resin Composition
10/551938	4/5/2004	7442434	10/28/2008	Epoxy Resin Composition
10/552902	4/5/2004	7468441	12/23/2008	1-Imidazolymethyl-substituted-2-Naphthols and their use as Accelerators for Low Temperature Curing

Application Number	Application Date	Patent Number	Grant Date	Patent
10/552908	4/13/2004			Accelerator Systems for Low Temperature Curing
878129	6/18/1997	6100351	8/8/2000	OLEFIN POLYMERIZATION PROCESS AND PRODUCTS THEREOF
630800	4/10/1996	5948447	9/7/1999	METHOD AND APPARATUS FOR PRODUCT RECOVERY OF POLYOLEFINS (RECOVERY OF STICKY POLYMERS USING TRANSPORTER TECHNOLOGY)
10/815532	7/20/2000	7223820	5/29/2007	Polymer Capto Polyamines as Epoxy Resin Hardeners
10/511924	4/18/2003	7307123	12/11/2007	Photocurable Compositions Containing Reactive Particles

TRADEMARKS

Mark	Status	Serial Number	Application Date	Registration Number	Registration Date
ARACAST	Registered	73033591	10/2/1974	1021345	9/30/1975
ARADUR	Registered	75917813	2/12/2000	2713897	5/6/2003
ARALDITE	Registered	71505805	7/18/1946	437125	3/9/1948
ARALDITE	Registered	71505804	7/18/1946	442493	4/19/1949
ARALDITE	Registered	75305125	6/9/1997	2187502	9/8/1998
ARATHANE	Registered	73649161	3/12/1987	1580878	2/6/1990
AROCY	Registered	73731512	5/31/1988	1539906	5/23/1989
EPOCAST	Registered	71670351	7/21/1954	612844	9/27/1955
Eposert	Registered	76136078	9/26/2000	2886879	9/21/2004
KERIMID	Registered	75305126	6/9/1997	2286963	10/19/1999
MATRIMID	Registered	73568176	11/12/1985	1437618	4/28/1987
OPALVA	Registered	76135278	9/26/2000	2773878	10/14/2003
PROBELEC	Registered	75519271	7/15/1998	2384635	9/12/2000
PROBIMAGE	Registered	74088811	8/17/1990	1773326	5/25/1993
PROBIMER	Registered	73044914	2/24/1975	1025999	12/2/1975
PROBIMER	Registered	74263027	4/6/1992	1783753	7/27/1993
REN (Stylised)	Registered	72055724	7/21/1958	678703	5/19/1959
REN (Stylised)	Registered	72059767	9/29/1958	710081	1/24/1961
Ren Patch	Registered	75/305129	6/9/1997	2200608	10/27/1998
REN SHAPE	Registered	75273991	4/14/1997	2208182	12/8/1998
REN SHAPE	Registered	72095762	4/25/1960	707695	11/29/1960
REN SHAPE-EXPRESS	Registered	75580688	11/2/1999	2433986	3/6/2001
RenCast	Registered	78381460	3/10/2004	2938093	4/5/2005
RenGel	Registered	78381178	3/9/2004	2930911	3/8/2005
RenInfusion	Registered	78381451	3/10/2004	2938092	4/5/2005
RenLam	Registered	78381471	3/10/2004	2954970	5/24/2005
RenLease	Registered	78381432	3/10/2004	2938091	4/5/2005
RenPaste	Registered	78381185	3/9/2004	2938090	4/5/2005
RenPIM	Registered	78381168	3/9/2004	2928026	2/22/2005
RenShape	Registered	78381159	3/9/2004	2929010	3/1/2005
RenShape	Registered	78381150	3/9/2004	2936305	3/29/2005
SILFLEX	Registered	73713308	2/25/1988	1555383	9/12/1989
TACTIX	Registered	73541701	6/6/1985	1373234	12/3/1985
URALANE	Registered	74588325	10/17/1994	1967928	4/16/1996
WEARGUARD	Registered	73650556	3/20/1987	1463200	11/3/1987
EPIBOND	Registered	71680670	1/28/1955	613707	10/11/1955
QUATREX	Registered	73508329	11/13/1984	1341836	6/18/1985
REN-WELD	Registered	75131014	7/8/1996	2077435	7/8/1997
Pur-Fect Tool	Registered	75864316	10/30/1999	2481643	8/28/2001